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Printer-friendly format 3M™ .100" x .100" 4-Wall Header, Standard, Straight Through-Hole, 26 Contacts, 2526-6002UB



.100" \times .100" Low Profile, Straight pin product with bend pad, Solder tails for .062 [1.57] thick board, Mating plating thickness solder tail versions 30 μ " [0.76 μ m].

[click to enlarge]

GTIN(UPC/EAN): 0 00 54007 82733 7

3M Id: 80-6105-6523-8

Additional Information

Packaging Data 2526-6002, 3D IGES, rev. 02 - 3D Models (ZIP 262.3 K) 2526-6002, 3D Parasolid, rev. 02 - 3D Models (ZIP 223.5 K) 2526-6002, 3D Step, rev. 02 - 3D Models (ZIP 180.0 K)

Characteristics

Contact Termination Area Plating	200 μ" [5.08 μm] 90/10 Tin/Lead			
Contact Underplating	100 μ" [2.54 μm] Nickel			
Contact Wiping Area Plating	30 μ" [0.76 μm] Gold			
Current Rating	2 Ampere			
EPC Can View	Public			
EU RoHS Compliant	No			
Insulation Flammability Rating	UL 94V-0			
Insulation Material	Glass Filled Polyester (PBT)			
Insulation Resistance	>1 X 10^9 Ohms @ 500 Vdc			
Interface Grid	.100" x .100"			
Interface Style	Header (Rectangular Plug)			
Latch/Ejector Type	None			
Markings	3M Logo and Orientation Triangle			
Mounting Option	None			
Non-Operating Temperature	-55 to 105 Degree Celsius			
Number of Contact Rows	2			
Number of Contacts	26			

Number of Walls	4		
Orientation	Vertical		
Pitch	0.100 Inch		
Polarization	Military & Center Bump		
Primary Trademark Name	3M		
Separable	Yes		
Tail Length	.112 Inch		
Termination Method	Solder Tail		
Termination Style	Printed Circuit Board		
Withstanding Voltage	1000 Vrms at Sea Level		

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.100" x .100" Low Profile, SMT Straight, Straight and Rt Angle Through-Hole

2500 Series



- Low profile, space saving design
- Center slot polarization prevents mis-insertions and reduces insertion time
- Dual slot polarization means broader compatibility with competitive polarization designs (not 10 pos.)
- Optional retainer clip for locking sockets in place and increasing connection reliability in vibration-prone environments
- Optional high temperature insulator suitable for "no lead" soldering operations
- High temperature option in through-hole version suitable for "paste in hole" reflow soldering techniques
- Exposed solder tails (on right angle version) provide ease of cleaning and reduced repair costs
- Straight surface mount version available
- See regulatory information appendix (RIA) for chemical compliance information

Date Modified: March 24, 2008

TS-0770-E Sheet 1 of 5

Physical

Insulator

Glass Filled Polyester (PBT), Glass Filled Polyester (PCT)-Material:

High Temperature Option

Flammability: UL 94V-0

Color: Gray (PBT), Beige (PCT) or Black (PCT)

Contact Material: Copper Alloy

Plating

Underplating: 100 µ" [2.54 µm] Nickel - Overall Wiping Area: Gold (See Ordering Information)

Solder Tails: 200 µ" [5.08 µm] Tin Lead or Matte Tin (See Ordering Information) Marking: 3M Logo, Part Identification Number and Orientation Triangle

Electrical

Current Rating: 2A

Insulation Resistance: >1 x 10⁹ W at 500 V_{DC} Withstanding Voltage: $1000 \, V_{RMS}$ at Sea Level

Environmental

Temperature Rating: -55° C to $+105^{\circ}$ C

Process Rating: 260°C, (High Temperature and PCT insulator versions only), single pass,

(profile per J-STD-020C) PBT insulator version, maximum molded

insulator temperature 191°C (solder wave process only)

Moisture Sensitivity Level: 1 (per J-STD-020C)

UL File No.: E68080

.100" x .100" Low Profile, Straight Through-Hole

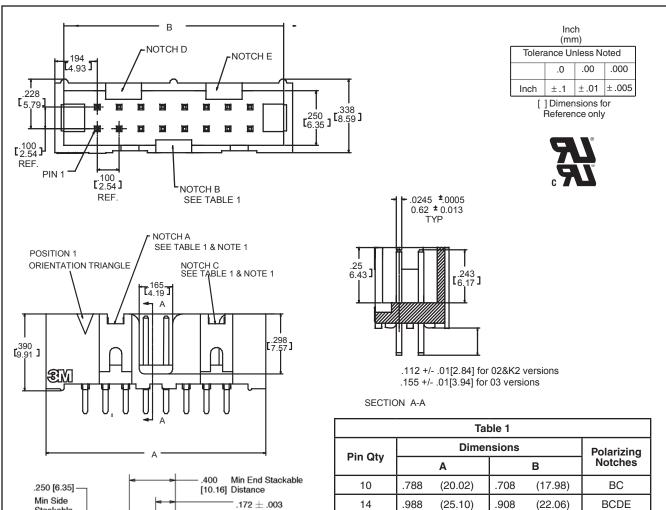


Table 1					
Din Oty	Dimensions			Polarizing	
Pin Qty		Α	В		Notches
10	.788	(20.02)	.708	(17.98)	ВС
14	.988	(25.10)	.908	(22.06)	BCDE
16	1.088	(27.64)	1.008	(25.60)	ABCDE
20	1.288	(32.72)	1.208	(30.68)	ABCDE
24	1.488	(37.80)	1.408	(35.76)	ABCDE
26	1.588	(40.34)	1.508	(38.30)	ABCDE
30	1.788	(45.42)	1.708	(43.38)	ABCDE
34	1.988	(50.50)	1.908	(48.46)	ABCDE
40	2.288	(58.12)	2.208	(56.08)	ABCDE
50	2.788	(70.82)	2.708	(68.78)	ABCDE
60	3.288	(83.52)	3.208	(81.48)	ABCDE
64	3.488	(88.60)	3.408	(86.56)	ABCDE

Stackable

Distance

 \oslash .035 \pm .003 [0.89]

Optional Hole for

Polarization Peg

Position 1 as indicated

by Triangle

- 1. Notches A & C will accomodate 3M Polarizing Keys (3M Part #3518 or N3518).
- 2. Contact tails .0245 [0.622] wire with .0075 [0.191] corner radii & .028 [.072] diagonal.

[4.37]

.035 [0.89] Dia

 0.050 ± 0.003 [1.27]

 $\pm .003$

[2.54]

 $\pm .003$

[2.54]

See page 4 for kink tail positions.

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4. Solder stand offs facilitate .01 clearance above board for reflow soldering.

Recommended P.C. Board Hole Pattern (Shown for mounting side of board.)

Ordering Information $UG = 15\mu$ " [0.38 μ m] Gold with 200 μ " [5.08 μ m] 60:40 Tin-Lead Solder Tails (RIA E3 & C2 apply) X25XX-60XX-XX UB = 30μ" [0.76μm] Gold with 200μ" [5.05μm] 60:40 Blank = Std. Temp. Gray (PBT)(UB or UG Pltg. Req'd) Tin-Lead Solder Tails (RIA E3 & C2 apply) N = High Temp. Beige (PCT)(UB or UG Pltg. Req'd) N = High Temp. Black (PCT)(RB Pltg. Reg'd) $RB = 30 \mu^{"} \, [0.76 \mu m] \, Gold \, with \, 200 \mu^{"} \, [5.08 \mu m]$ Matte Tin Solder Tails (RIA E1 & C1 apply) Solder Tail 02 = for .062 [1.57] thick boardPin Quantity: 03 = for .094 to .125 [2.39 to 3.18] TS-0770-E (See Table 1) thick board Sheet 2 of 5 K2 = for .062 [1.57] thick board

.100" x .100" Low Profile, Straight Through-Hole

